

Notice for TAIYO YUDEN products

Please read this notice before using the TAIYO YUDEN products.

/!\ REMINDERS

Product Information in this Catalog

Product information in this catalog is as of October 2019. All of the contents specified herein and production status of the products listed in this catalog are subject to change without notice due to technical improvement of our products, etc. Therefore, please check for the latest information carefully before practical application or use of our products.

Please note that TAIYO YUDEN shall not be in any way responsible for any damages and defects in products or equipment incorporating our products, which are caused under the conditions other than those specified in this catalog or individual product specification sheets.

Approval of Product Specifications

Please contact TAIYO YUDEN for further details of product specifications as the individual product specification sheets are available. When using our products, please be sure to approve our product specifications or make a written agreement on the product specification with TAIYO YUDEN in advance.

Pre-Evaluation in the Actual Equipment and Conditions

Please conduct validation and verification of our products in actual conditions of mounting and operating environment before using our products.

Limited Application

1. Equipment Intended for Use

The products listed in this catalog are intended for generalpurpose and standard use in general electronic equipment (e.g., AV equipment, OA equipment, home electric appliances, office equipment, information and communication equipment including, without limitation, mobile phone, and PC) and other equipment specified in this catalog or the individual product specification sheets.

TAIYO YUDEN has the line-up of the products intended for use in automotive electronic equipment, telecommunications infrastructure and industrial equipment, or medical devices classified as GHTF Classes A to C (Japan Classes I to III). Therefore, when using our products for these equipment, please check available applications specified in this catalog or the individual product specification sheets and use the corresponding products.

2. Equipment Requiring Inquiry

Please be sure to contact TAIYO YUDEN for further information before using the products listed in this catalog for the following equipment (excluding intended equipment as specified in this catalog or the individual product specification sheets) which may cause loss of human life, bodily injury, serious property damage and/or serious public impact due to a failure or defect of the products and/or malfunction attributed thereto.

- (1) Transportation equipment (automotive powertrain control system, train control system, and ship control system, etc.)
- (2) Traffic signal equipment
- (3) Disaster prevention equipment, crime prevention equipment
- (4) Medical devices classified as GHTF Class C (Japan Class III)
- (5) Highly public information network equipment, dataprocessing equipment (telephone exchange, and base station, etc.)
- (6) Any other equipment requiring high levels of quality and/or reliability equal to the equipment listed above

3. Equipment Prohibited for Use

Please do not incorporate our products into the following equipment requiring extremely high levels of safety and/or reliability.

- (1) Aerospace equipment (artificial satellite, rocket, etc.)
- (2) Aviation equipment *1
- (3) Medical devices classified as GHTF Class D (Japan Class IV), implantable medical devices *2

- (4) Power generation control equipment (nuclear power, hydroelectric power, thermal power plant control system, etc.)
- (5) Undersea equipment (submarine repeating equipment, underwater work equipment, etc.)
- (6) Military equipment
- (7) Any other equipment requiring extremely high levels of safety and/or reliability equal to the equipment listed above

*Notes:

- 1. There is a possibility that our products can be used only for aviation equipment that does not directly affect the safe operation of aircraft (e.g., in-flight entertainment, cabin light, electric seat, cooking equipment) if such use meets requirements specified separately by TAIYO YUDEN. Please be sure to contact TAIYO YUDEN for further information before using our products for such aviation equipment.
- Implantable medical devices contain not only internal unit which is implanted in a body, but also external unit which is connected to the internal unit.

4. Limitation of Liability

Please note that unless you obtain prior written consent of TAIYO YUDEN, TAIYO YUDEN shall not be in any way responsible for any damages incurred by you or third parties arising from use of the products listed in this catalog for any equipment that is not intended for use by TAIYO YUDEN, or any equipment requiring inquiry to TAIYO YUDEN or prohibited for use by TAIYO YUDEN as described above.

Safety Design

When using our products for high safety and/or reliability-required equipment or circuits, please fully perform safety and/or reliability evaluation. In addition, please install (i) systems equipped with a protection circuit and a protection device and/or (ii) systems equipped with a redundant circuit or other system to prevent an unsafe status in the event of a single fault for a failsafe design to ensure safety.

Intellectual Property Rights

Information contained in this catalog is intended to convey examples of typical performances and/or applications of our products and is not intended to make any warranty with respect to the intellectual property rights or any other related rights of TAIYO YUDEN or any third parties nor grant any license under such rights.

Limited Warranty

Please note that the scope of warranty for our products is limited to the delivered our products themselves and TAIYO YUDEN shall not be in any way responsible for any damages resulting from a failure or defect in our products. Notwithstanding the foregoing, if there is a written agreement (e.g., supply and purchase agreement, quality assurance agreement) signed by TAIYO YUDEN and your company, TAIYO YUDEN will warrant our products in accordance with such agreement

■ TAIYO YUDEN's Official Sales Channel

The contents of this catalog are applicable to our products which are purchased from our sales offices or authorized distributors (hereinafter "TAIYO YUDEN's official sales channel"). Please note that the contents of this catalog are not applicable to our products purchased from any seller other than TAIYO YUDEN's official sales channel.

Caution for Export

Some of our products listed in this catalog may require specific procedures for export according to "U.S. Export Administration Regulations", "Foreign Exchange and Foreign Trade Control Law" of Japan, and other applicable regulations. Should you have any questions on this matter, please contact our sales staff.

WIRE-WOUND CHIP POWER INDUCTORS(BR SERIES)





■PARTS NUMBER

* Operating Temp.:-40~+105°C (Including self-generated heat)

△=Blank space

B R	ΔL	2	5	1	8	Т	2	R	2	М	Δ	Δ	Δ
1	2		(3)		4		(5)		6		7	

(1)Series name

Code	Series name
BR	Wire-Wound chip power inductor

2Characteristics

Code	Characteristics						
FL							
ΔL	Low profile						
HL							
ΔC	High current						

③Dimensions (L × W)

@ Dillionologio (E				
Code	Type (inch)	Dimensions (L×W) [mm]		
1608	1608(0603)	1.6 × 0.8		
2012	2012(0805)	2.0 × 1.25		
2016	2016(0806)	2.0 × 1.6		
2518	2518(1007)	2.5 × 1.8		
3225	3225(1210)	3.2 × 2.5		

4 Packaging

Code	Packaging
Т	Taping

(5)Nominal inductance

_	
Code (example)	Nominal inductance[μ H]
R20	0.2
1R0	1.0
100	10
101	100

※R=Decimal point

6 Inductance tolerance

Code	Inductance tolerance
K	±10%
М	±20%

7Internal code

■STANDARD EXTERNAL DIMENSIONS / STANDARD QUANTITY

Recommended Land Patterns

Surface Mounting

•Mounting and soldering conditions should be checked beforehand.

· Applicable soldering process to these products is reflow soldering only.



Туре	Α	В	С
1608	0.55	0.70	1.00
2012	0.60	1.00	1.45
2016	0.60	1.00	1.80
2518	0.60	1.50	2.00
3225	0.85	1.70	2.70

Unit:mm

Type		W	Т		Standard qu	uantity[pcs]
Type	L	VV		е	Paper tape	Embossed tape
BR L1608	1.6±0.2 (0.063±0.008)	0.8 ± 0.2 (0.031 ± 0.008)	0.7 max (0.028 max)	0.45±0.15 (0.016±0.006)	_	3000
BR C1608	1.6±0.2 (0.063±0.008)	0.8±0.2 (0.031±0.008)	0.8±0.2 (0.031±0.008)	0.45±0.15 (0.016±0.006)	_	3000
BR L2012	2.0±0.2 (0.079±0.008)	1.25±0.2 (0.049±0.008)	1.0 max (0.040 max)	0.5±0.2 (0.020±0.008)	_	3000
BR C2012	2.0±0.2 (0.079±0.008)	1.25±0.2 (0.049±0.008)	1.4 max (0.056 max)	0.5±0.2 (0.020±0.008)	-	2000
BR C2016	2.0±0.2 (0.079±0.008)	1.6±0.2 (0.063±0.008)	1.6±0.2 (0.063±0.008)	0.5±0.2 (0.020±0.008)	-	2000
BRFL2518	2.5±0.2 (0.098±0.008)	1.8±0.2 (0.071±0.008)	1.0 max (0.040 max)	0.5±0.2 (0.020±0.008)	-	3000
BR L2518	2.5±0.2 (0.098±0.008)	1.8±0.2 (0.071±0.008)	1.2 max (0.048 max)	0.5 ± 0.2 (0.020 \pm 0.008)	_	3000
BRHL2518	2.5±0.2 (0.098±0.008)	1.8±0.2 (0.071±0.008)	1.5 max (0.060 max)	0.5±0.2 (0.020±0.008)	_	2000
BR C2518	2.5±0.2 (0.098±0.008)	1.8±0.2 (0.071±0.008)	1.8±0.2 (0.071±0.008)	0.5±0.2 (0.020±0.008)	-	2000
BR L3225	3.2±0.2 (0.126±0.008)	2.5±0.2 (0.098±0.008)	1.7 max (0.068 max)	0.75±0.2 (0.03±0.008)	-	2000
	•			•		Unit:mm(inch)

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1608(0603)type								
		Manada al Carda atama		Self-resonant	DC Resistance	Rated curren	Measuring	
Parts number	EHS	Nominal inductance [μ H]	Inductance tolerance	frequency [MHz] (min.)	[Ω](±30%)	Saturation current Idc1	Temperature rise current Idc2	frequency[MHz]
BR L1608T1R0M	RoHS	1.0	±20%	700	0.230	510	650	1.0
BR L1608T1R5M	RoHS	1.5	±20%	600	0.280	440	590	1.0
BR L1608T2R2M	RoHS	2.2	±20%	400	0.400	360	500	1.0
BR L1608T3R3M	RoHS	3.3	±20%	300	0.650	290	390	1.0
BR L1608T4R7M	RoHS	4.7	±20%	150	1.00	240	310	1.0
BR L1608T6R8M	RoHS	6.8	±20%	100	1.64	200	250	1.0
BR L1608T100M	RoHS	10	±20%	45	2.00	170	220	1.0
DD L 1000T1FOM	D.HC	15	+000/	20	0.50	150	000	1.0

		Nominal inductance		Self-resonant	DC Resistance	Rated curren	Measuring	
Parts number	EHS	[μ H]	Inductance tolerance	frequency [MHz] (min.)	$[\Omega](\pm 30\%)$	Saturation current Idc1	t ※) [mA] Temperature rise current Idc2 1,100 1,050 940 810 730 680	frequency[MHz]
BR C1608TR43M 6	RoHS	0.43	±20%	740	0.082	1,400	1,100	6.0
BR C1608TR50M 6	RoHS	0.50	±20%	710	0.090	1,200	1,050	6.0
BR C1608TR60M 6	RoHS	0.60	±20%	630	0.099	1,100	940	6.0
BR C1608TR72M 6	R₀HS	0.72	±20%	600	0.144	1,000	810	6.0
BR C1608TR82M 6	RoHS	0.82	±20%	560	0.176	950	730	6.0
BR C1608T1R0M 6	R₀HS	1.0	±20%	550	0.188	890	680	6.0

		Nominal inductance		Self-resonant	DC Resistance	Rated curren	Measuring	
Parts number	EHS	[μ H]	Inductance tolerance	frequency [MHz] (min.)	$[\Omega](\pm 30\%)$	Saturation current Idc1	Temperature rise current Idc2	frequency[MHz]
BR C1608TR20M	RoHS	0.20	±20%	400	0.060	1,750	980	7.96
BR C1608TR35M	RoHS	0.35	±20%	300	0.080	1,400	810	7.96
BR C1608TR45M	RoHS	0.45	±20%	200	0.090	1,250	800	7.96
BR C1608TR56M	RoHS	0.56	±20%	170	0.095	1,150	760	7.96
BR C1608TR77M	RoHS	0.77	±20%	150	0.110	1,000	660	7.96
BR C1608T1R0M	RoHS	1.0	±20%	140	0.180	850	520	7.96
BR C1608T1R5M	RoHS	1.5	±20%	120	0.300	700	410	7.96
BR C1608T2R2M	R₀HS	2.2	±20%	100	0.550	550	280	7.96

■2012(080<u>5</u>)type

		Nominal inductance		Self-resonant	DC Resistance	Rated curren	t ※)[mA]	Measuring
Parts number	EHS	[μ H]	Inductance tolerance	frequency [MHz] (min.)	$[\Omega](\pm 30\%)$	Saturation current Idc1	Temperature rise current Idc2	frequency[MHz]
BR L2012TR47M 6	RoHS	0.47	±20%	500	0.048	1,500	1,900	6.0
BR L2012T1R0M 6	RoHS	1.0	±20%	400	0.108	1,050	1,230	6.0
BR L2012T2R2MD6	RoHS	2.2	±20%	250	0.184	680	950	6.0

		M		Self-resonant	DO D	Rated curren	t ※)[mA]		
Parts number	EHS	Nominal inductance [μ H]	Inductance tolerance	frequency [MHz] (min.)	DC Resistance [Ω](±30%)	Saturation current Idc1	Temperature rise current Idc2	Measuring frequency[MHz]	
BR L2012TR47M	RoHS	0.47	±20%	350	0.090	1,100	1,050	7.96	
BR L2012T1R0M	RoHS	1.0	±20%	300	0.135	850	850	7.96	
BR L2012T1R5M	RoHS	1.5	±20%	250	0.180	700	750	7.96	
BR L2012T2R2M	RoHS	2.2	±20%	200	0.300	600	550	7.96	
BR L2012T3R3M	RoHS	3.3	±20%	190	0.500	490	440	7.96	
BR L2012T4R7M	RoHS	4.7	±20%	150	0.550	340	400	7.96	
BR L2012T6R8M	RoHS	6.8	±20%	60	0.750	290	350	7.96	
BR L2012T100M	RoHS	10	±20%	30	0.850	270	330	2.52	
BR L2012T150M	RoHS	15	±20%	15	1.00	220	300	2.52	
BR L2012T220M	RoHS	22	±20%	13	1.30	190	270	2.52	
BR L2012T330M	RoHS	33	±20%	8.0	2.00	150	220	2.52	
BR L2012T470M	RoHS	47	±20%	7.0	3.50	125	160	2.52	
BR L2012T680M	RoHS	68	±20%	6.5	5.80	100	110	2.52	
BR L2012T101M	RoHS	100	±20%	6.0	7.70	85	85	0.796	

		Nominal inductance		Self-resonant	DC Resistance	Rated current ※)[mA]		Measuring
Parts number	EHS	[μ H]	Inductance tolerance	frequency [MHz] (min.)	$[\Omega](\pm 30\%)$	Saturation current Idc1	Temperature rise current Idc2	frequency[MHz]
BR C2012T1R0M	RoHS	1.0	±20%	490	0.060	1,500	1,400	1.0
BR C2012T1R5MD	RoHS	1.5	±20%	390	0.090	1,200	1,100	1.0
BR C2012T2R2MD	RoHS	2.2	±20%	350	0.110	1,100	1,000	1.0
BR C2012T3R3MD	RoHS	3.3	±20%	300	0.170	800	870	1.0
BR C2012T4R7MD	RoHS	4.7	±20%	250	0.265	700	600	1.0

 $[\]stackrel{\frown}{\otimes}$) The temperature rise current value (Idc2) is the DC current value having temperature increase by 40°C. (at 20°C)

 $[\]mbox{\ensuremath{\mbox{\%}}}\mbox{\ensuremath{\mbox{\mbox{\mbox{$\%$}}}}\mbox{\ensuremath{\mbox{\mbox{1}}}}\mbox{\ensuremath{\mbox{\mbox{2}}}\mbox{\ensuremath{\mbox{4}}}\mbox{\ensuremath{\mbox{4}}\mbox{\ensuremath{\mbox{4}}}\mbox{\ensuremath{\mbox{4}}\mbox{\ensure$

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2016 (0806) type

		Nominal inductance		Self-resonant	DC Resistance	Rated curren	t ※)[mA]	Measuring
Parts number	EHS	[μ H]	Inductance tolerance	frequency [MHz] (min.)	$[\Omega](\pm 30\%)$	Saturation current Idc1	Temperature rise current Idc2	frequency[MHz]
BR C2016T1R0M	RoHS	1.0	±20%	450	0.085	1,350	1,100	0.10
BR C2016T1R5M	RoHS	1.5	±20%	370	0.150	1,100	820	0.10
BR C2016T2R2M	RoHS	2.2	±20%	250	0.180	910	760	0.10
BR C2016T3R3M	RoHS	3.3	±20%	140	0.220	740	680	0.10
BR C2016T4R7M	RoHS	4.7	±20%	78	0.270	660	610	0.10
BR C2016T6R8M	RoHS	6.8	±20%	39	0.330	550	560	0.10
BR C2016T100[]	RoHS	10	±10%, ±20%	35	0.400	450	520	0.10
BR C2016T150[]	RoHS	15	±10%, ±20%	28	0.600	400	410	0.10
BR C2016T220[]	RoHS	22	±10%, ±20%	24	1.00	310	310	0.10
BR C2016T330[]	RoHS	33	±10%, ±20%	13	1.70	270	240	0.10
BR C2016T470[]	RoHS	47	±10%, ±20%	11	2.20	210	210	0.10
BR C2016T680[]	RoHS	68	±10%, ±20%	8	2.80	200	190	0.10
BR C2016T101[]	RoHS	100	±10%, ±20%	7	3.40	140	170	0.10

2518(1007)type

		Nominal inductance		Self-resonant	DC Resistance	Rated current ※)[mA]		Measuring
Parts number	EHS	[μ H]	Inductance tolerance	frequency [MHz] (min.)	$[\Omega](\pm 30\%)$	Saturation current Idc1	Temperature rise current Idc2	frequency[MHz]
BRFL2518T1R0M	RoHS	1.0	±20%	130	0.090	1,200	1,200	1.0
BRFL2518T1R5M	RoHS	1.5	±20%	100	0.110	1,100	1,000	1.0
BRFL2518T2R2M	RoHS	2.2	±20%	80	0.130	850	950	1.0
BRFL2518T3R3M	RoHS	3.3	±20%	70	0.220	700	700	1.0
BRFL2518T4R7M	RoHS	4.7	±20%	60	0.330	650	650	1.0

		Nominal inductance		Self-resonant	DC Resistance	Rated curren	t ※)[mA]	Manada
Parts number	EHS	[μ H]	Inductance tolerance	frequency [MHz] (min.)	$[\Omega](\pm 30\%)$	Saturation current Idc1	Temperature rise current Idc2	Measuring frequency[MHz]
BR L2518T1R0M	RoHS	1.0	±20%	130	0.080	1,600	1,000	7.96
BR L2518T1R5M	RoHS	1.5	±20%	100	0.100	1,200	920	7.96
BR L2518T2R2M	RoHS	2.2	±20%	80	0.135	1,000	850	7.96
BR L2518T3R3M	RoHS	3.3	±20%	70	0.300	800	580	7.96
BR L2518T4R7M	RoHS	4.7	±20%	60	0.400	700	470	7.96

		Nominal inductance		Self-resonant	DC Resistance	Rated current ※)[mA]		Managed
Parts number	EHS	Nominal inductance [μ H]	Inductance tolerance	frequency [MHz] (min.)	[Ω](±30%)	Saturation current Idc1	Temperature rise current Idc2	Measuring frequency[MHz]
BRHL2518T1R0M	RoHS	1.0	±20%	400	0.055	2,000	1,400	1.0
BRHL2518T1R5M	RoHS	1.5	±20%	350	0.085	1,700	1,100	1.0
BRHL2518T2R2M	RoHS	2.2	±20%	300	0.115	1,500	1,000	1.0
BRHL2518T3R3MD	RoHS	3.3	±20%	200	0.165	1,200	800	1.0
BRHL2518T4R7MD	RoHS	4.7	±20%	150	0.245	1,100	750	1.0

		M		Self-resonant	DO D	Rated curren	t ※)[mA]	
Parts number	EHS	Nominal inductance [μ H]	Inductance tolerance	frequency [MHz] (min.)	DC Resistance [Ω](±30%)	Saturation current Idc1	Temperature rise current Idc2	Measuring frequency[MHz]
BR C2518T1R0M	RoHS	1.0	±20%	280	0.050	2,550	1,650	1.0
BR C2518T1R5M	RoHS	1.5	±20%	230	0.080	2,100	1,300	1.0
BR C2518T2R2M	RoHS	2.2	±20%	200	0.120	1,800	1,000	1.0
BR C2518T3R3M	RoHS	3.3	±20%	150	0.175	1,450	860	1.0
BR C2518T4R7M	RoHS	4.7	±20%	100	0.230	1,250	750	1.0
BR C2518T6R8M	RoHS	6.8	±20%	45	0.280	1,050	680	1.0
BR C2518T100□	RoHS	10	±10%, ±20%	20	0.350	890	610	1.0
BR C2518T150[]	RoHS	15	±10%, ±20%	13	0.430	760	550	1.0
BR C2518T220[]	RoHS	22	±10%, ±20%	10	0.560	640	490	1.0
BR C2518T330[]	RoHS	33	±10%, ±20%	8	0.850	560	390	1.0
BR C2518T470[]	RoHS	47	±10%, ±20%	6.5	1.45	410	300	1.0
BR C2518T680[]	RoHS	68	±10%, ±20%	5.5	2.40	340	230	1.0
BR C2518T101[]	RoHS	100	±10%, ±20%	4.5	3.60	300	190	1.0

^{• ☐} Please specify the inductance tolerance code. (M or K)

^{*}X) The saturation current value (Idc1) is the DC current value having inductance decrease down to 30%. (at 20°C)

^{*)} The temperature rise current value (Idc2) is the DC current value having temperature increase by 40°C. (at 20°C)

 $[\]ensuremath{\mbox{\%}}\xspace) The rated current value is following either Idc1 or Idc2, which is the lower one.$

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3225(1210)type

3223(1210)type								
		Nominal inductance			DC Resistance	Rated current ※)[mA]		Measuring
Parts number	EHS	[μ H]	Inductance tolerance		[Ω](±30%)	Saturation current Idc1	Temperature rise current Idc2	frequency[MHz]
BR L3225TR27M	RoHS	0.27	±20%	390	0.022	4,500	2,850	7.96
BR L3225TR36M	RoHS	0.36	±20%	350	0.025	4,300	2,750	7.96
BR L3225TR51M	RoHS	0.51	±20%	270	0.029	3,600	2,550	7.96

		Manada al Sankarkan an		Self-resonant	DO De distance	Rated curren	t ※)[mA]	Manager
Parts number	EHS	Nominal inductance [μ H]	Inductance tolerance	frequency [MHz] (min.)	DC Resistance [Ω](±20%)	Saturation current Idc1	Temperature rise current Idc2	Measuring frequency[MHz]
BR L3225T1R0M	RoHS	1.0	±20%	220	0.043	2,400	2,200	0.1
BR L3225T1R5M	RoHS	1.5	±20%	170	0.045	2,200	1,750	0.1
BR L3225T2R2M	R₀HS	2.2	±20%	150	0.065	1,850	1,600	0.1
BR L3225T3R3M	R₀HS	3.3	±20%	140	0.120	1,450	1,200	0.1
BR L3225T4R7M	RoHS	4.7	±20%	120	0.180	1,300	1,000	0.1
BR L3225T6R8M	RoHS	6.8	±20%	90	0.270	1,050	770	0.1
BR L3225T100[]	RoHS	10	±10%, ±20%	70	0.350	900	700	0.1
BR L3225T150[]	RoHS	15	±10%, ±20%	20	0.570	700	530	0.1
BR L3225T220[]	R₀HS	22	±10%, ±20%	13	0.690	550	470	0.1
BR L3225T330[]	RoHS	33	±10%, ±20%	9	0.840	470	420	0.1
BR L3225T470[]	R ₀ HS	47	±10%, ±20%	7	1.00	420	390	0.1
BR L3225T680[]	RoHS	68	±10%, ±20%	6	1.40	330	300	0.1
BR L3225T101[]	RoHS	100	±10%, ±20%	5	2.50	270	250	0.1

<sup>•
☐</sup> Please specify the inductance tolerance code. (M or K)

 $[\]frak{\%}$) The saturation current value (Idc1) is the DC current value having inductance decrease down to 30%. (at 20°C)

[%]) The temperature rise current value (Idc2) is the DC current value having temperature increase by 40°C. (at 20°C)

^{*)} The rated current value is following either Idc1 or Idc2, which is the lower one.

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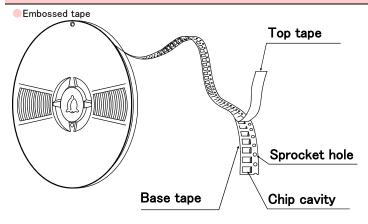
WIRE-WOUND CHIP POWER INDUCTORS (BR SERIES)

PACKAGING

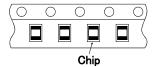
1 Minimum Quantity

Type	Standard Qu	uantity [pcs]
туре	Paper Tape	Embossed Tape
BR C1608	_	3,000
BR L1608	_	3,000
BR L2012	_	3,000
BR C2012	_	2,000
BR C2016	_	2,000
BR C2518	_	2,000
BRHL2518	_	2,000
BR L2518	_	3,000
BRFL2518	_	3,000
BR L3225	_	2,000

②Tape Material

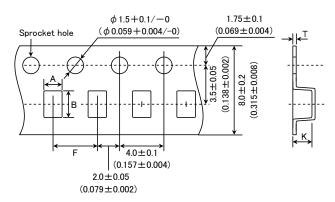


Chip Filled



3 Taping dimensions

Embossed Tape 8mm wide (0.315 inches wide)

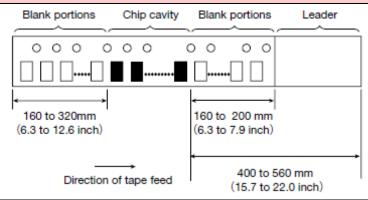


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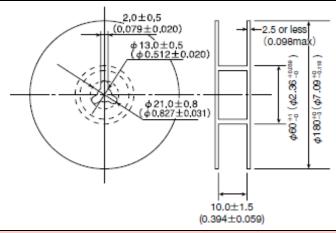
T	Chip	cavity	Insertion pitch	Tape th	ickness
Туре	Α	В	F	Т	K
BR L1608	1.1±0.1	1.9±0.1	4.0±0.1	0.2±0.05	0.9 max
BR L1008	(0.043 ± 0.004)	(0.075 ± 0.004)	(0.157 ± 0.004)	(0.008 ± 0.002)	(0.035 max)
BR C1608	1.1±0.1	1.9±0.1	4.0±0.1	0.25±0.05	1.2 max
DR 01000	(0.043 ± 0.004)	(0.075 ± 0.004)	(0.157 ± 0.004)	(0.010 ± 0.002)	(0.047 max)
BR L2012	1.45±0.1	2.2±0.1	4.0±0.1	0.25 ± 0.05	1.2 max
DR LZ01Z	(0.057 ± 0.004)	(0.087 ± 0.004)	(0.157 ± 0.004)	(0.010 ± 0.002)	(0.047 max)
BR C2012	1.45±0.1	2.37±0.1	4.0±0.1	0.25 ± 0.05	1.59 max
DR G2012	(0.057 ± 0.004)	(0.093 ± 0.004)	(0.157 ± 0.004)	(0.010 ± 0.002)	(0.063 max)
BR C2016	1.75±0.1	2.1±0.1	4.0±0.1	0.3 ± 0.05	1.9 max
DR 02010	(0.069 ± 0.004)	(0.083 ± 0.004)	(0.157 ± 0.004)	(0.012 ± 0.002)	(0.075 max)
BRFL2518	2.3±0.1	2.8±0.1	4.0±0.1	0.25 ± 0.05	1.3 max
DRFLZJ10	(0.091 ± 0.004)	(0.110 ± 0.004)	(0.157 ± 0.004)	(0.010 ± 0.002)	(0.051 max)
BR L2518	2.3±0.1	2.8±0.1	4.0±0.1	0.3 ± 0.05	1.45 max
DR LZJ16	(0.091 ± 0.004)	(0.110 ± 0.004)	(0.157 ± 0.004)	(0.012 ± 0.002)	(0.057 max)
BRHL2518	2.1±0.1	2.8±0.1	4.0±0.1	0.3 ± 0.05	1.7 max
DRILLZUIO	(0.083 ± 0.004)	(0.110 ± 0.004)	(0.157 ± 0.004)	(0.012 ± 0.002)	(0.067 max)
BR C2518	2.15±0.1	2.7±0.1	4.0±0.1	0.3 ± 0.05	2.2 max
DR 02310	(0.085 ± 0.004)	(0.106 ± 0.004)	(0.157 ± 0.004)	(0.012 ± 0.002)	(0.087 max)
BR L3225	2.8±0.1	3.5±0.1	4.0±0.1	0.25 ± 0.05	1.9 max
DR LUZZU	(0.110 ± 0.004)	(0.138 ± 0.004)	(0.157 ± 0.004)	(0.010 ± 0.002)	(0.075 max)

Unit:mm(inch)

4 Leader and Blank portion

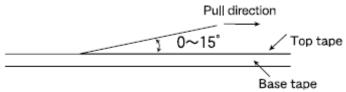


5Reel size



6Top Tape Strength

The top tape requires a peel-off force of 0.2 to 0.7N in the direction of the arrow as illustrated below.



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WIRE-WOUND CHIP POWER INDUCTORS (BR SERIES)

■RELIABILITY DATA

1. Operating Tempe	rature Range	
Specified Value	BR series	-40~+105°C
Test Methods and Remarks	Including self-generated heat	
2. Storage Tempera	ture Range(after soldering)	
Specified Value	BR series	-40~+85°C
Test Methods and Remarks	Please refer the term of "7.Storage condition	ns" in Precautions.
3. Rated current		
Specified Value	BR series	Within the specified tolerance
4. Inductance		
Specified Value	BR series	Within the specified tolerance
Test Methods and Remarks	Measuring equipment : LCR Meter (H Measuring frequency : Specified frequency	HP 4285A or equivalent) uency
5. DC Resistance		
Specified Value	BR series	Within the specified tolerance
Test Methods and Remarks		(HIOKI 3227 or equivalent)
6. Self resonance fr		100 L
Specified Value	BR series	Within the specified tolerance
Test Methods and Remarks		alyzer/material analyzer equivalent HP4191A, 4192A or equivalent)
7. Temperature cha	racteristic	
Specified Value	BR series	Inductance change : Within ±15%
Test Methods and Remarks	Based on the inductance at 20°C and Measu	
0.0.1.	1 1199	
8. Resistance to the	•	
Specified Value	BR series	No damage.
Test Methods and Remarks	Dimension of the board : 100 ×	and then the back side of the board is pushed until it bends 2mm like the figure. 40×1.0 mm (0.8mm thickness for $1608(0603)$ inductors) epoxy-resin mm

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0.0.1.1.11				
9. Body strength				
Specified Value	BR series		No damage.	
Test Methods and	2012~			
Remarks	Applied orce 10N			
	Duration : 10sec.			
	1608 size			
	Applied force : 5N Duration : 10sec.			
	Duration . 105ec.			
10. Adhesion of terr	ninal electrodes			
Specified Value	BR series		Not to removed from the board.	
Test Methods and	The given sample is soldered to	o the board an	d then it is kept for 5sec with 10N stress (5N for 160 $$	08(0603) inductors) like the figure.
Remarks				
	☐ 10N (5N fo	r 1608(0603) inductors	
11. Resistance to vi	bration			
			Inductance change : Within ±10%	
Specified Value	BR series		No significant abnormality in appearance.	
Test Methods and	The given sample is soldered to	o the board an	d then it is tested depending on the conditions of the	e following table.
Remarks	Vibration Frequency	10∼55Hz		
	Total Amplitude	1.5mm (May n	ot exceed acceleration 196m/s2)	
	Sweeping Method	1	to 10Hz for 1min.	
		X		
	Time	Z	For 2 hours on each X, Y, and Z axis.	
	Recovery : At least 2hrs of r		the standard condition after the test, followed by the	e measurement within 48hrs
	Trocovery . The loader Elling of the	- Coovery arraor	and dearman a contained area and edge, removed by a	o modear omene warmin terme.
10.0.11.122				
12. Solderability				
Specified Value	BR series		At least 90% area of the electrodes is covered by n	ew solder.
Test Methods and	Test Method and Remarks			
Remarks	Flux : Methanol solution contain		then it is tested depending on the conditions of the f	ollowing table.
	Tiux . Michianor solution contain			
	Solder Temperature			
	Solder Temperature Time	245±5°C 5±0.5 sec.		
	· · · · · · · · · · · · · · · · · · ·	245±5°C		
13 Resistance to s	Time	245±5°C	<u> </u>	
13. Resistance to se	Time	245±5°C	Trade at the same of Within the 100	
13. Resistance to se	Time	245±5°C	Inductance change : Within ±10% No significant abnormality in appearance	
Specified Value	Time Oldering heat BR series	245±5°C 5±0.5 sec.	No significant abnormality in appearance.	220°C
Specified Value Test Methods and	Time Didering heat BR series 3 times reflow having the temp	245±5°C 5±0.5 sec.	_	230°C.
Specified Value	Time Didering heat BR series 3 times reflow having the temp Test board thickness : 1.0m	245±5°C 5±0.5 sec.	No significant abnormality in appearance.	230℃.
Specified Value Test Methods and	Time Didering heat BR series 3 times reflow having the temp Test board thickness : 1.0m Test board material : Glas	245±5°C 5±0.5 sec.	No significant abnormality in appearance.	
Specified Value Test Methods and	Time Didering heat BR series 3 times reflow having the temp Test board thickness : 1.0m Test board material : Glas	245±5°C 5±0.5 sec.	No significant abnormality in appearance. of 5sec of 260+0/ -5 $^{\circ}\text{C}$ and 40sec of more than	
Specified Value Test Methods and	Time Didering heat BR series 3 times reflow having the temp Test board thickness : 1.0m Test board material : Glas	245±5°C 5±0.5 sec.	No significant abnormality in appearance. of 5sec of 260+0/ -5 $^{\circ}\text{C}$ and 40sec of more than	
Specified Value Test Methods and Remarks	Time Didering heat BR series 3 times reflow having the temp Test board thickness : 1.0m Test board material : Glas	245±5°C 5±0.5 sec.	No significant abnormality in appearance. of 5sec of $260+0/-5$ °C and 40sec of more than the standard condition after the test, followed by the	
Specified Value Test Methods and Remarks	Time Didering heat BR series 3 times reflow having the temp Test board thickness : 1.0m Test board material : Glas	245±5°C 5±0.5 sec.	No significant abnormality in appearance. of 5sec of $260+0/-5$ °C and 40sec of more than the standard condition after the test, followed by the Inductance change: Within $\pm 10\%$	
Specified Value Test Methods and Remarks 14. Thermal shock Specified Value	Time BR series 3 times reflow having the temp Test board thickness : 1.0m Test board material : Glas Recovery : At least 2hrs of r	erature profile	No significant abnormality in appearance. of 5sec of $260\pm0/-5$ °C and 40sec of more than the standard condition after the test, followed by the Inductance change: Within $\pm 10\%$ No significant abnormality in appearance.	e measurement within 48hrs.
Specified Value Test Methods and Remarks 14. Thermal shock	Time BR series 3 times reflow having the temp Test board thickness : 1.0m Test board material : Glas Recovery : At least 2hrs of r	erature profile m es epoxy-resin recovery under	No significant abnormality in appearance. of 5sec of $260+0/-5$ °C and 40sec of more than the standard condition after the test, followed by the Inductance change: Within $\pm 10\%$	e measurement within 48hrs.
Specified Value Test Methods and Remarks 14. Thermal shock Specified Value Test Methods and	Time BR series 3 times reflow having the temp Test board thickness : 1.0m Test board material : Glas Recovery : At least 2hrs of r BR series The given sample is soldered to	erature profile m es epoxy-resin recovery under	No significant abnormality in appearance. of 5sec of $260\pm0/-5$ °C and 40sec of more than the standard condition after the test, followed by the Inductance change: Within $\pm 10\%$ No significant abnormality in appearance.	e measurement within 48hrs.
Specified Value Test Methods and Remarks 14. Thermal shock Specified Value Test Methods and	Time BR series 3 times reflow having the temp Test board thickness : 1.0m Test board material : Glas Recovery : At least 2hrs of r BR series The given sample is soldered to Condition Step Temperature (°C)	erature profile m es epoxy-resin recovery under	No significant abnormality in appearance. of 5sec of 260+0/-5 °C and 40sec of more than the standard condition after the test, followed by the Inductance change: Within ±10% No significant abnormality in appearance. d then its Inductance is measured after 100cycles of Duration (min)	e measurement within 48hrs.
Specified Value Test Methods and Remarks 14. Thermal shock Specified Value Test Methods and	Time BR series 3 times reflow having the temp Test board thickness : 1.0m Test board material : Glas Recovery : At least 2hrs of r BR series The given sample is soldered to Condition Step Temperature (°C 1 -40±3	erature profile m ss epoxy-resin recovery under	No significant abnormality in appearance. of 5sec of $260+0/-5$ °C and 40 sec of more than the standard condition after the test, followed by the Inductance change: Within $\pm 10\%$ No significant abnormality in appearance. d then its Inductance is measured after 100cycles of Duration (min) 30 ± 3	e measurement within 48hrs.
Specified Value Test Methods and Remarks 14. Thermal shock Specified Value Test Methods and	Time BR series 3 times reflow having the temp Test board thickness : 1.0m Test board material : Glas Recovery : At least 2hrs of r BR series The given sample is soldered to Condition Step Temperature (°C)	erature profile m ss epoxy-resin recovery under	No significant abnormality in appearance. of 5sec of 260+0/-5 °C and 40sec of more than the standard condition after the test, followed by the Inductance change: Within ±10% No significant abnormality in appearance. d then its Inductance is measured after 100cycles of Duration (min)	e measurement within 48hrs.
Specified Value Test Methods and Remarks 14. Thermal shock Specified Value Test Methods and	Time BR series 3 times reflow having the temp Test board thickness : 1.0m Test board material : Glas Recovery : At least 2hrs of r BR series The given sample is soldered to Condition Step Temperature (°C 1 —40±3 2 Room temperature	erature profile mm ss epoxy-resin recovery under	No significant abnormality in appearance. of 5sec of $260+0/-5$ °C and 40 sec of more than the standard condition after the test, followed by the standard condition after the test, followed by the Inductance change: Within $\pm 10\%$ No significant abnormality in appearance. d then its Inductance is measured after 100cycles of Duration (min) 30 ± 3 Within 3	e measurement within 48hrs.

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15. Damp heat			
Specified Value	BR series		Inductance change : Within ±10%
Specified Value BR series			No significant abnormality in appearance.
Test Methods and	The given sample is soldered to the board an		d then it is kept at the following conditions.
Remarks	Temperature	60±2°C	
	Humidity	90∼95%RH	
	Time	1000 hours.	
	Recovery : At leas	t 2hrs of recovery under	the standard condition after the test, followed by the measurement within 48 hrs.
16. Loading under d	amp heat		
			Inductance change : Within ±10%
Specified Value	BR series		No significant abnormality in appearance.
Test Methods and	The given sample is s	oldered to the board and	d then it is kept at the following conditions.
Remarks	Temperature	60±2°C	7
	Humidity	90∼95%RH	
	Applied current	Rated current	
	Time	1000hours.	
	Recovery : At leas	t 2hrs of recovery under	the standard condition after the test, followed by the measurement within 48 hrs.
17. Low temperature	e life test		
			Inductance change : Within ±10%
Specified Value	BR series		No significant abnormality in appearance.
Test Methods and	The given sample is s	oldered to the board and	d then it is kept at the following conditions.
Remarks	Temperature	-40±2°C	
	Duration	1000hours	
	Recovery : At leas		the standard condition after the test, followed by the measurement within 48 hrs.
18. High temperatur	e life test		
			Inductance change : Within ±10%
Specified Value	BR series		No significant abnormality in appearance.
Test Methods and	The given sample is s	oldered to the board an	d then it is kept at the following conditions.
Remarks	Temperature	85±2°C	
	Duration	1000hours	=
		t 2hrs of recovery under	□ the standard condition after the test, followed by the measurement within 48 hrs.
19. Standard conditi	ions		
			Standard test condition :
			Unless otherwise specified, temperature is 20±15°C and 65±20%of relative humidity.
0 :0 17/1	BR series		When there is any question concerning measurement result: In order to provide
Specified Value			correlation data, the test shall be condition of 20±2°C of temperature, 65±5% relative
			humidity.
			Inductance is in accordance with our measured value.

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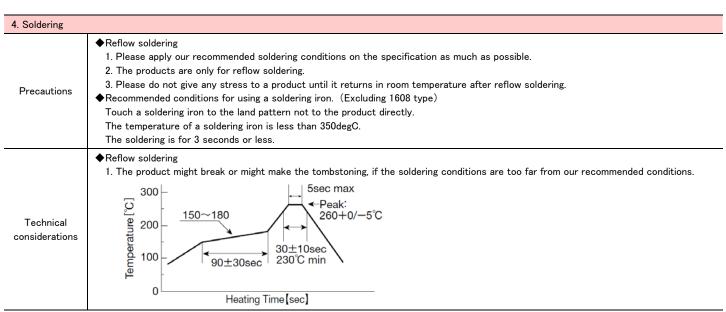
WIRE-WOUND CHIP POWER INDUCTORS (BR SERIES)

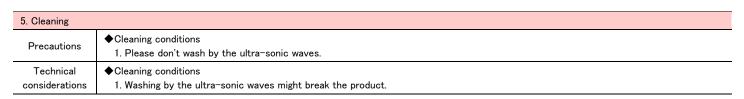
■PRECAUTIONS

1. Circuit Design Operating Ambient The products are premised on the usage for the general equipments like the office supply equipment, the telecommunications systems, the measuring equipment, the household equipment and so on. Please ask to TAIYO YUDEN's sales person in advance, if you need to apply them to the equipments or the systems which might have any influences for the human body, the property, like the traffic systems, the safety equipment, the aerospace systems, the nuclear control systems, the medical equipment and soon.

2. PCB Design	
Precautions	◆Land pattern design 1. Please refer to a recommended land pattern.
Technical considerations	 ◆Land pattern design Surface Mounting 1. The conditions of the picking and placing should be checked in advance. 2. The products are only for reflow soldering.

3. Considerations for automatic placement	
Precautions	◆Adjustment of mounting machine 1. Excessive physical impact should not be imposed on the products for picking and placing onto the PC boards. 2. Mounting and soldering conditions should be checked in advance.
Technical considerations	◆Adjustment of mounting machine The products might be broken if too much stress is given for the picking and placing.





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6. Handling	
Precautions	 ✦ Handling 1. Keep the product away from any magnets. ✦ Cutting the PC boards 1. Please don't give any stress of the bending or the twisting for the cutting process of PC boards. 2. Please don't give any shock and stress to the products in transportation. ✦ Mechanical considerations 1. Please don't give too much shock to the product. 2. Please don't give any shock and stress to the products in transportation. ✦ The stress for picking and placing 1. Please don't give any shock into an exposed ferrite core. ✦ Packing 1. Please don't pile the packing boxes up as much as possible.
Technical considerations	 ✦Handling 1. There is a case that a characteristic varies with magnetic influence. ✦Cutting the PC boards 1. Please don't give the bending stress or the twisting stress to the products because they might break in such cases. ✦Mechanical considerations 1. The mechanical shock might break the products. 2. The products might break depending on the handling in transportation. ✦Pick-up pressure 1. The electrical characteristics of the products might be shifted by too much physical shock and stress. ✦Packing 1. The products and the tape might break, if the packing boxes are piled up.

7. Storage condit	zions
Precautions	 ♦ Storage 1. To maintain the solderability of terminal electrodes and to keep the packing material in good condition, temperature and humidity in the storage area should be controlled. • Recommended conditions Ambient temperature : 0~40°C Humidity : Below 70% RH • The ambient temperature must be kept below 30°C. Even under ideal storage conditions, solderability of products electrodes may decrease as time passes. For this reason, product should be used within 6 months from the time of delivery. In case of storage over 6 months, solderability shall be checked before actual usage.
Technical considerations	◆Storage 1. The ambient of high temperature or high humidity might accelerate to make the solderability and the tape worse.